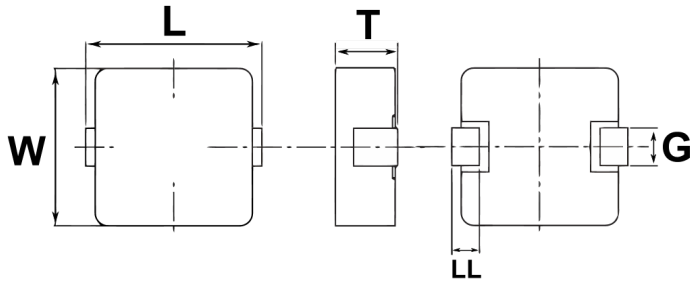


MPLC0730L3R3

Aliases (UPID0730L3R300)

Not for New Design

KEMET, MPLC, Metal Composite, 20%, 3300 nH, 3026



Click [here](#) for the 3D model.

Dimensions

Chip Size	3026
L	7.7mm MAX
W	6.7mm +/-0.2mm
T	3mm MAX
G	3.2mm +/-0.1mm

Packaging Specifications

Packaging	T&R, 330mm
Packaging Quantity	1000

General Information

Series	MPLC
Style	SMD Molded
Core	Metal Composite
Description	Shielded, Surface Mount Inductor
Features	Large Current Inductors
RoHS	Yes

Specifications

Inductance	3300 nH
Inductance Tolerance	20%
Temperature Range	-40/+125°C
Shielded	Yes
Current	6.5 Amps (Isat, 20% Drop In Inductance), 5.7 Amps (Irms, 40C Rise By Self Heating)
DC Resistance	30 mOhms

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.